

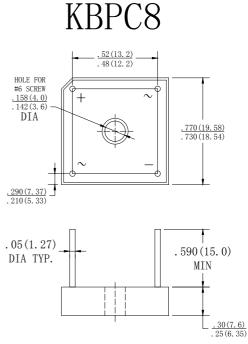
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Features

- · Ideal for printed circuit board
- Reliable low cost construction technique results in inexpensive product
- High temperature soldering guaranteed: 250° C / 10 seconds / 0.375" (9.5mm) lead length at 5 lbs., (2.3 kg) tension

Mechanical Data

- Case: Molded plastic
- Lead: solder plated
- Polarity: As marked



Dimensions in inches and (millimeters)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Rating at 25 $^\circ\!\mathrm{C}$ $\,$ ambient temperature unless otherwise specified.

Single phase, half wave, 60 Hz, resistive or inductive load.

For capacitive load, derate current by 20%

Type Number		BR 10005	BR 1001	BR 1002	BR 1004	BR 1006	BR 1008	BR 1010	UNITS
Maximum Repetitive Peak Reverse Voltage	VRRM	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	VRMS	35	70	140	280	420	560	700	V
Maximum DC blocking Voltage	VDC	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current $@Tc = 50$ °c	l(AV)	10							А
Peak Forward Surge Current, 8.3 ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I _{FSM}	200							А
Maximum Instantaneous Forward Voltage @5.0A	V _F	1.1							V
Maximum DC Reverse Current @ TA=25 $^\circ\!\!\mathbb{C}$ rated DC blocking voltage per leg TA = 100 $^\circ\!\!\mathbb{C}$	I _R	5.0 500							μ Α
Typical Thermal Resistance (Note)	Rθjc	2.5							°C/W
Operating Temperature Range	TJ	-55 to +125							°C
Storage Temperature Range	Tstg	-55 to +150							°C

NOTE: Thermal Resistance from junction to case with units mounted on a 3.2" x 3.2" x 0.12" (8.2cm.x 8.2cm.x 0.3cm.) Al.-Finned Plate.



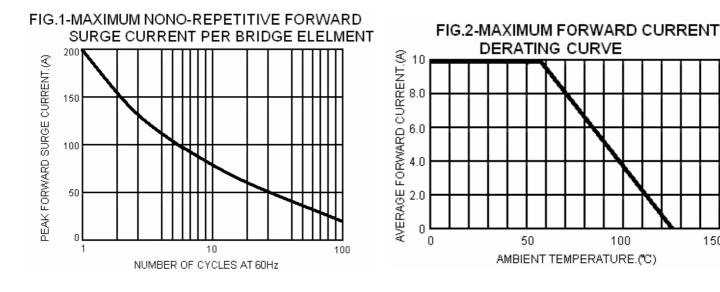
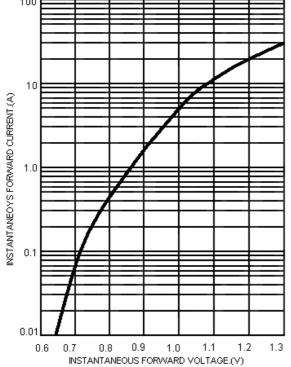
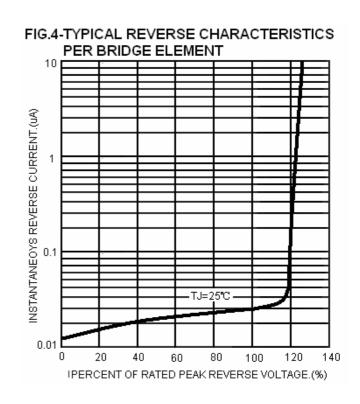


FIG.3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS PER BRIDGE ELEMENT 100





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